- Functionally Equivalent to AMD's AM29863
- Power-Up High-Impedance State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (NT) 300-mil DIPs

#### description

This 9-bit transceiver is designed for asynchronous two-way communication between data buses. The control-function implementation allows for maximum flexibility in timing.

This device allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic levels at the output-enable (OEAB1, OEAB2, OEBA1, and OEBA2) inputs.

The SN74ALS29863 is characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.

OEBA1       1       24       V <sub>CC</sub> A1       2       23       B1         A2       3       22       B2         A3       4       21       B3         A4       5       20       B4         A5       6       19       B5         A6       7       18       B6	DW OR NT PACKAGE (TOP VIEW)								
A7 [ 8 17 ] B7 A8 [ 9 16 ] B8 A9 [ 10 15 ] B9 OEBA2 [ 11 14 ] OEAB2 GND [ 12 13 ] OEAB1	A1 [ A2 [ A3 [ A4 [ A5 [ A6 [ A7 [ A8 [ A9 [ OEBA2 ]	3 4 5 6 7 8 9 10 11	23 22 21 20 19 18 17 16 15 14	B1 B2 B3 B4 B5 B6 B7 B8 B9 OEAB2					

FUNCTION TABLE									
	INP								
OEAB1	OEAB2	OEBA1	OEBA2	OPERATION					
L	L	L	L	Latch A and B					
L	L	Н	Х						
L	L	Х	Н	A to B					
Н	Х	L	L						
Х	Н	L	L	B to A					
Н	Х	Н	Х						
н	Х	Х	Н	laslation					
Х	Н	Х	Н	isolation					
Х	Н	Н	Х						
н н х	X X H	X X	H H	B to A					

#### FUNCTION TABLE

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

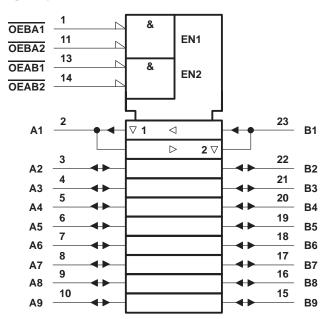


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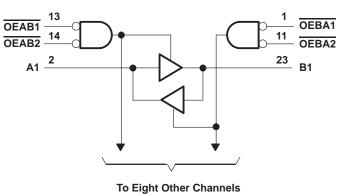
# SN74ALS29863 9-BIT TRANSCEIVER WITH 3-STATE OUTPUTS

SDAS096C - JANUARY 1986 - REVISED JANUARY 1995

## logic symbol<sup>†</sup>



logic diagram (positive logic)



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>‡</sup>

Supply voltage, V <sub>CC</sub>	
Input voltage, V <sub>I</sub> (all inputs and I/O ports)	5.5 V
Operating free-air temperature range, TA	
Storage temperature range	

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.75	5	5.25	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
IOH	High-level output current			-24	mA
IOL	Low-level output current			48	mA
TA	Operating free-air temperature	0		70	°C



# SN74ALS29863 **9-BIT TRANSCEIVER** WITH 3-STATE OUTPUTS

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#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	NDITIONS	MIN	TYP†	MAX	UNIT
VIK		V <sub>CC</sub> = 4.75 V,	lj = – 18 mA			-1.2	V
			I <sub>OH</sub> = – 15 mA	2.4			
VOH		V <sub>CC</sub> = 4.75 V	I <sub>OH</sub> = -24 mA	2			V
VOL		V <sub>CC</sub> = 4.75 V,	I <sub>OL</sub> = 48 mA		0.35	0.5	V
II .		V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 5.5 V			0.1	mA
	Control inputs					20	
ΙН	A or B ports <sup>‡</sup>	V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 2.7 V			20	μA
	Control inputs					-0.1	
ΊL	A or B ports <sup>‡</sup>	V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 0.4 V			-0.1	mA
los§		V <sub>CC</sub> = 5.25 V,	$V_{O} = 0$	-75		-250	mA
ICC		V <sub>CC</sub> = 5.25 V			40	65	mA

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. <sup>‡</sup> For I/O ports, the parameters I<sub>IH</sub> and I<sub>IL</sub> include the off-state output current. § Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

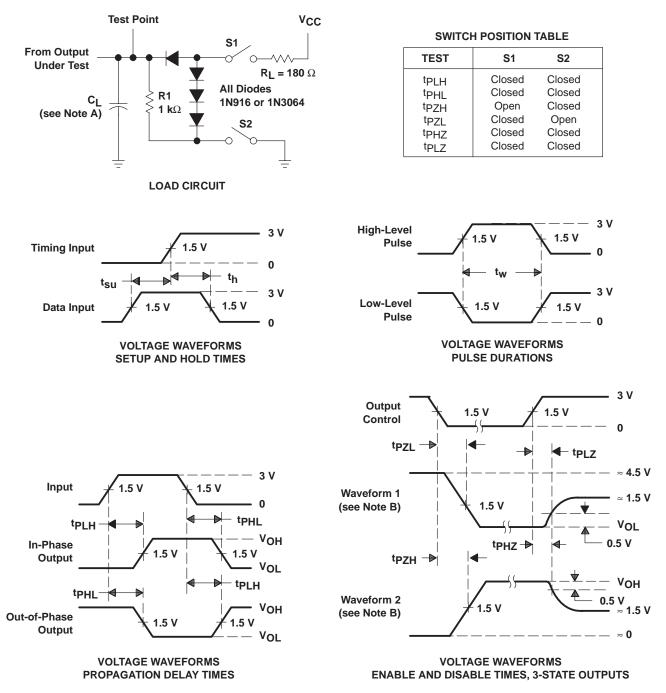
### switching characteristics (see Figure 1)

DADAMETER	FROM	FROM TO (INPUT) (OUTPUT) TEST CONDITIONS		V <sub>CC</sub> = 4.75 V to 5.25 V		
PARAMETER	(INPUT)			MIN MAX	UNIT	
<sup>t</sup> PLH	A D	Dank	0 000 - 5	15		
<sup>t</sup> PHL	A or B	B or A	C <sub>L</sub> = 300 pF	15	ns	
<sup>t</sup> PLH	A	Dank	0 50 - 5	8		
<sup>t</sup> PHL	A or B	B or A	C <sub>L</sub> = 50 pF	8	ns	
<sup>t</sup> PZH	0545 0554	AD	0 000 5	20		
<sup>t</sup> PZL	OEAB or OEBA	A or B	C <sub>L</sub> = 300 pF	23	ns	
<sup>t</sup> PZH				15		
<sup>t</sup> PZL	OEAB or OEBA	A or B	C <sub>L</sub> = 50 pF	15	ns	
<sup>t</sup> PHZ	0545 0554		0 50 5	17		
<sup>t</sup> PLZ	OEAB or OEBA	A or B	C <sub>L</sub> = 50 pF	12	ns	
<sup>t</sup> PHZ	OEAB or OEBA	A or P	0. E = E	9		
<sup>t</sup> PLZ	UEAD OF UEBA	A or B	C <sub>L</sub> = 5 pF	9	ns	



# SN74ALS29863 9-BIT TRANSCEIVER WITH 3-STATE OUTPUTS

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PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω, t<sub>f</sub> ≤ 2.5 ns, t<sub>f</sub> ≤ 2.5 ns.

Figure 1. Load Circuit and Voltage Waveforms



### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74ALS29863DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863DWR	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863DWRE4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863DWRG4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS29863NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

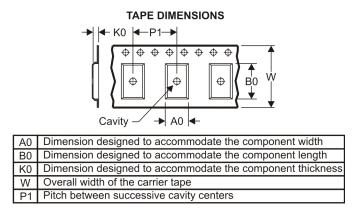
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## TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	
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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS29863DWR	SOIC	DW	24	2000	330.0	24.4	10.75	15.7	2.7	12.0	24.0	Q1



# PACKAGE MATERIALS INFORMATION

11-Mar-2008



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS29863DWR	SOIC	DW	24	2000	346.0	346.0	41.0

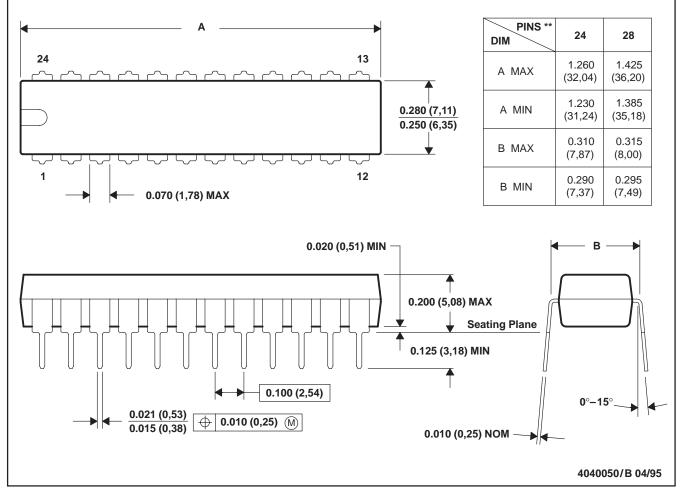
# **MECHANICAL DATA**

MPDI004 - OCTOBER 1994

### NT (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters). B. This drawing is subject to change without notice.



DW (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AD.



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